DATA SHEET

RENESAS

MOS FIELD EFFECT TRANSISTOR
μPA2755AGR

SWITCHING
N-CHANNEL POWER MOS FET

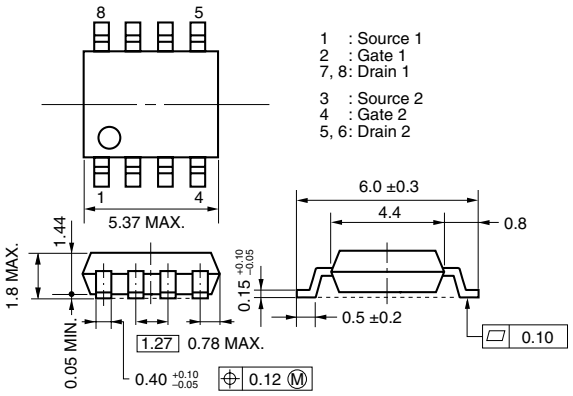
DESCRIPTION

The μPA2755AGR is Dual N-channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

FEATURES

- Dual chip type
- Low on-state resistance
  $R_{DS(on)1}$ = 18 mΩ MAX. (V_{GS} = 10 V, I_D = 4.0 A)
  $R_{DS(on)2}$ = 29 mΩ MAX. (V_{GS} = 4.5 V, I_D = 4.0 A)
- Low input capacitance
  C_{iss} = 650 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

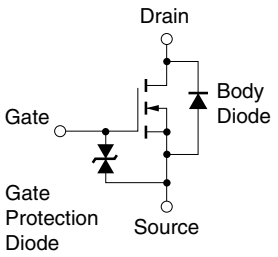
PACKAGE DRAWING (Unit: mm)



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, All terminals are connected.)

Drain to Source Voltage (V_{GS} = 0 V)	V_{DSS}	30	V
Gate to Source Voltage (V_{DS} = 0 V)	V_{GSS}	±20	V
Drain Current (DC) (T_C = 25°C)	$I_{D(DC)}$	±8.0	A
Drain Current (pulse) Note1	$I_{D(pulse)}$	±32	A
Total Power Dissipation (1 unit) Note2	P_T	1.7	W
Total Power Dissipation (2 units) Note2	P_T	2.0	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature	T_{stg}	–55 to +150	°C
Single Avalanche Current Note3	I_{AS}	8	A
Single Avalanche Energy Note3	E_{AS}	6.4	mJ

EQUIVALENT CIRCUIT
(1/2 circuit)



Notes 1. PW ≤ 10 μs, Duty Cycle ≤ 1%

2. Mounted on ceramic substrate of 2000 mm^2 x 2.2 mm

3. Starting T_{ch} = 25°C, V_{DD} = 15 V, R_G = 25 Ω, V_{GS} = 20 → 0 V

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

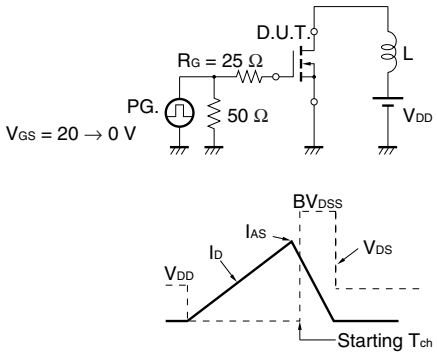
Document No. G19282EJ1V0DS00 (1st edition)
Date Published May 2008 NS
Printed in Japan

ELECTRICAL CHARACTERISTICS (T_A = 25°C, All terminals are connected.)

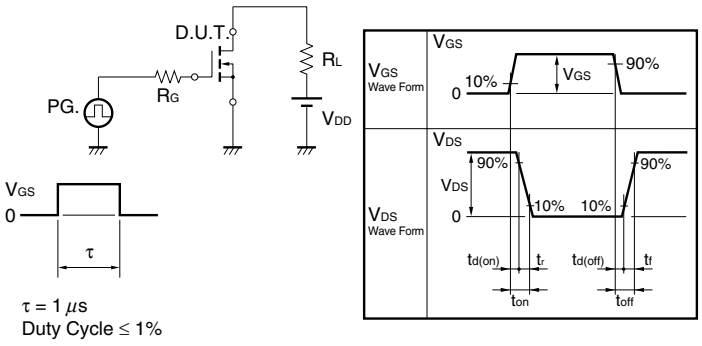
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 30 V, V_{GS} = 0 V			10	μA
Gate Leakage Current	I_{GSS}	V_{GS} = ±18 V, V_{DS} = 0 V			±10	μA
Gate to Source Cut-off Voltage	$V_{GS(off)}$	V_{DS} = 10 V, I_D = 1 mA	1.5		2.5	V
Forward Transfer Admittance **Note**	$\|y_{fs}\|$	V_{DS} = 10 V, I_D = 4.0 A	2.8	5.7		S
Drain to Source On-state Resistance **Note**	$R_{DS(on)1}$	V_{GS} = 10 V, I_D = 4.0 A		14	18	mΩ
	$R_{DS(on)2}$	V_{GS} = 4.5 V, I_D = 4.0 A		21	29	mΩ
Input Capacitance	C_{iss}	V_{DS} = 10 V		650		pF
Output Capacitance	C_{oss}	V_{GS} = 0 V		150		pF
Reverse Transfer Capacitance	C_{rss}	f = 1 MHz		98		pF
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = 15 V, I_D = 4.0 A		12		ns
Rise Time	t_r	V_{GS} = 10 V		16		ns
Turn-off Delay Time	$t_{d(off)}$	R_G = 10 Ω		38		ns
Fall Time	t_f			8.0		ns
Total Gate Charge	Q_G	V_{DD} = 24 V		13		nC
Gate to Source Charge	Q_{GS}	V_{GS} = 10 V		2.2		nC
Gate to Drain Charge	Q_{GD}	I_D = 8.0 A		3.8		nC
Body Diode Forward Voltage **Note**	$V_{F(S-D)}$	I_F = 8.0 A, V_{GS} = 0 V		0.84		V
Reverse Recovery Time	t_{rr}	I_F = 8.0 A, V_{GS} = 0 V		17		ns
Reverse Recovery Charge	Q_{rr}	di/dt = 100 A/μs		8.2		nC

Note Pulsed

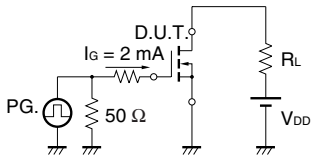
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

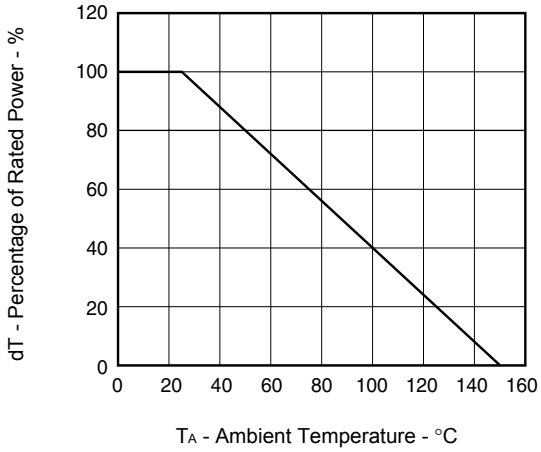


TEST CIRCUIT 3 GATE CHARGE

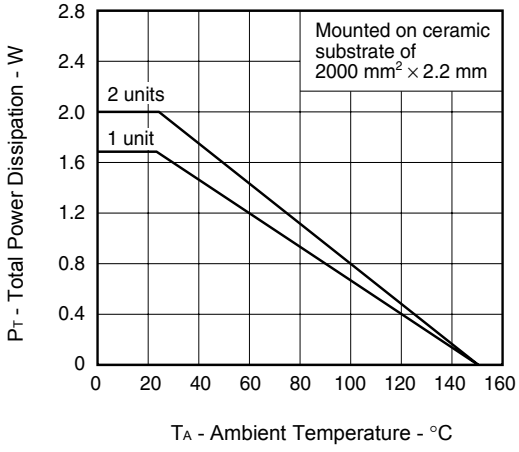


TYPICAL CHARACTERISTICS (T_A = 25°C)

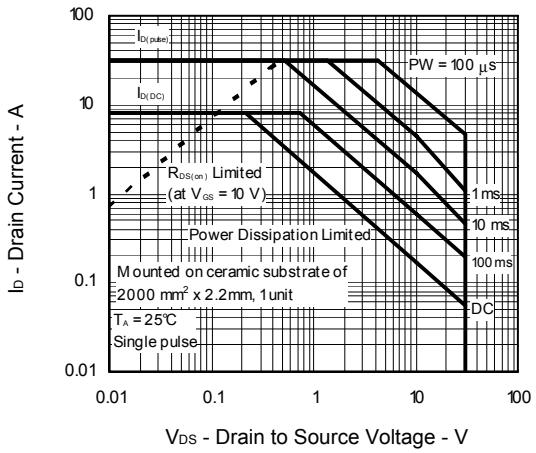
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



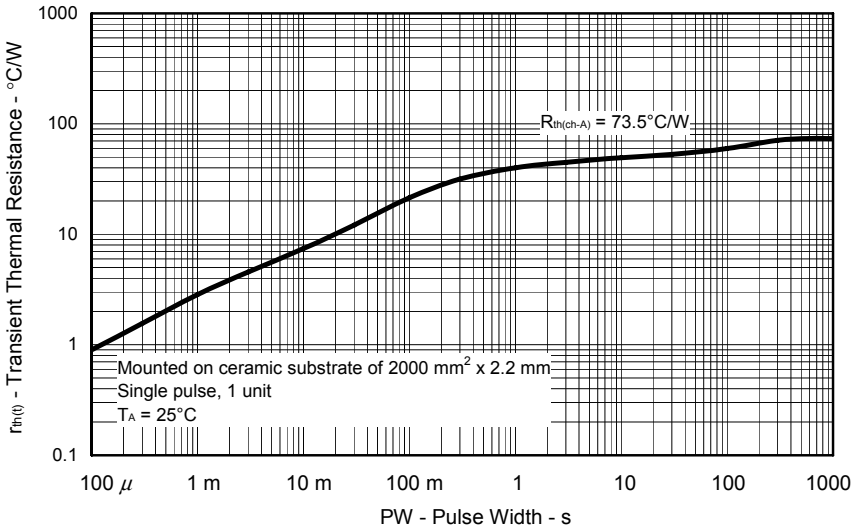
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



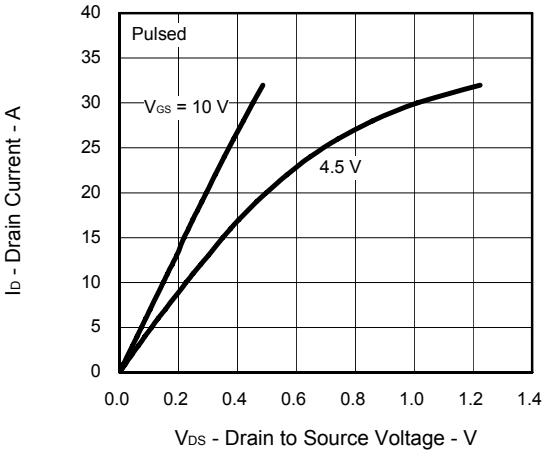
FORWARD BIAS SAFE OPERATING AREA



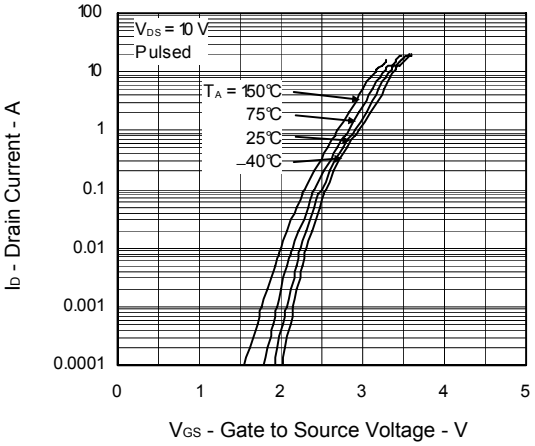
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



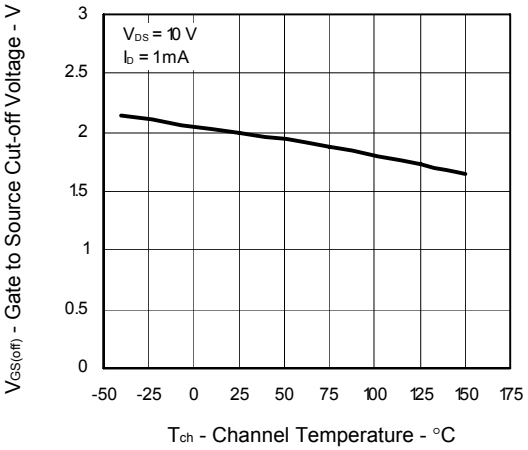
DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE



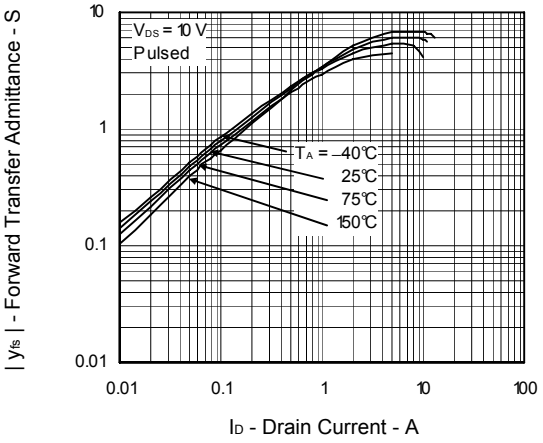
FORWARD TRANSFER CHARACTERISTICS



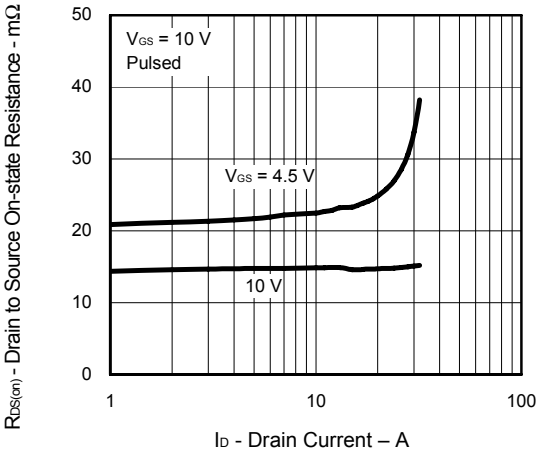
GATE TO SOURCE CUT-OFF VOLTAGE vs.
CHANNEL TEMPERATURE



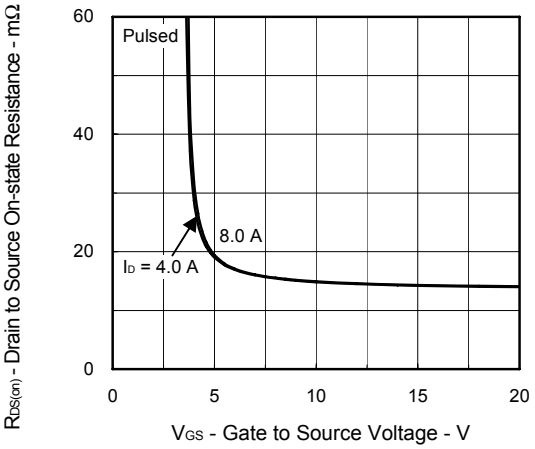
FORWARD TRANSFER ADMITTANCE vs.
DRAIN CURRENT



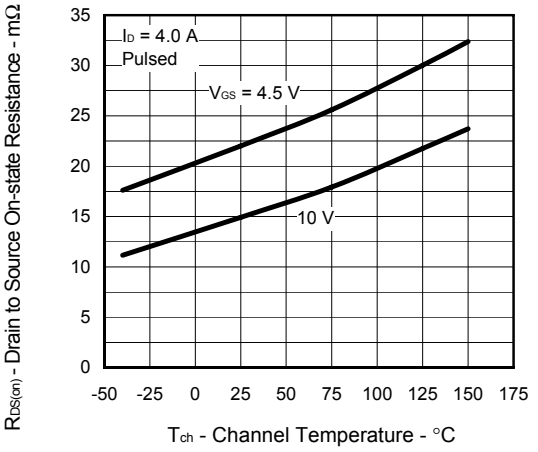
DRAIN TO SOURCE ON-STATE RESISTANCE vs.
DRAIN CURRENT



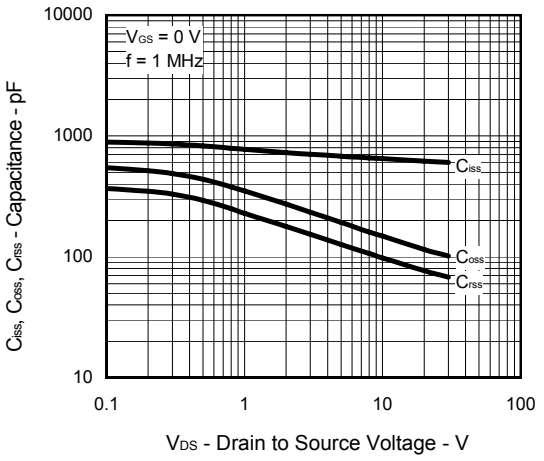
DRAIN TO SOURCE ON-STATE RESISTANCE vs.
GATE TO SOURCE VOLTAGE



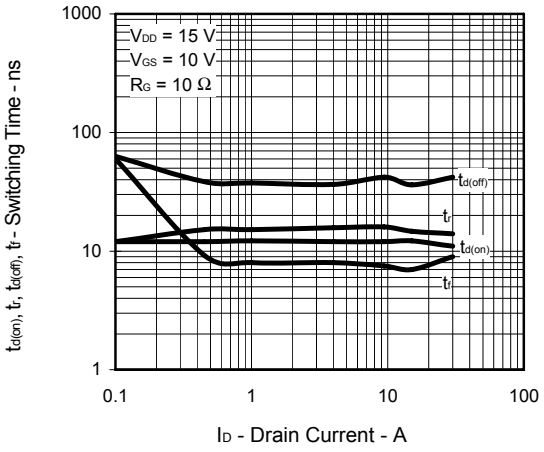
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



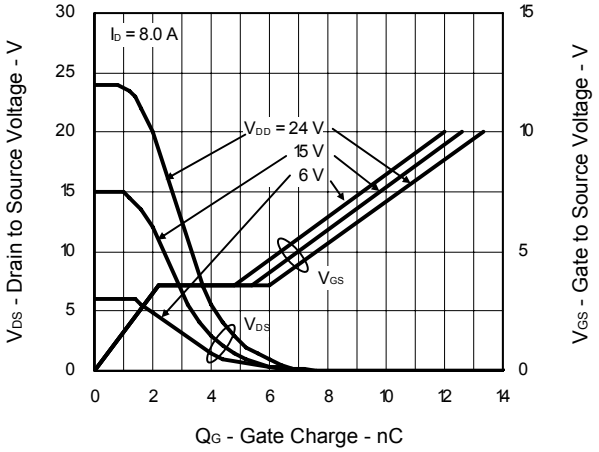
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



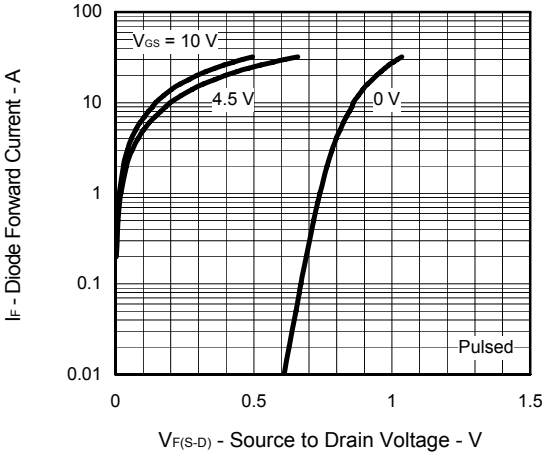
SWITCHING CHARACTERISTICS



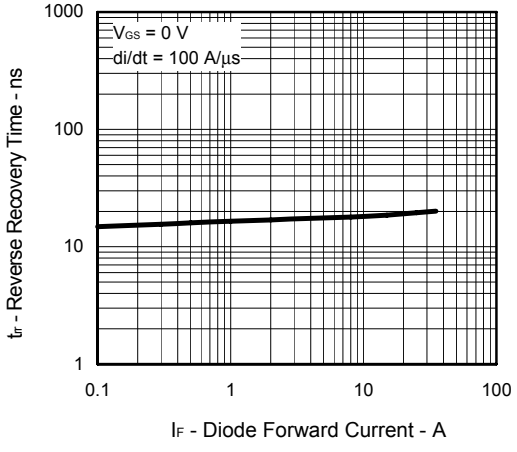
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



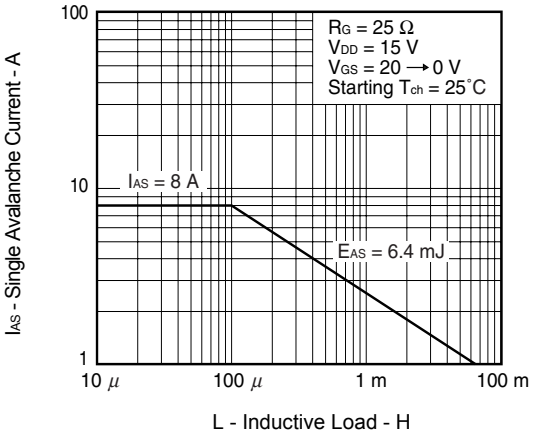
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



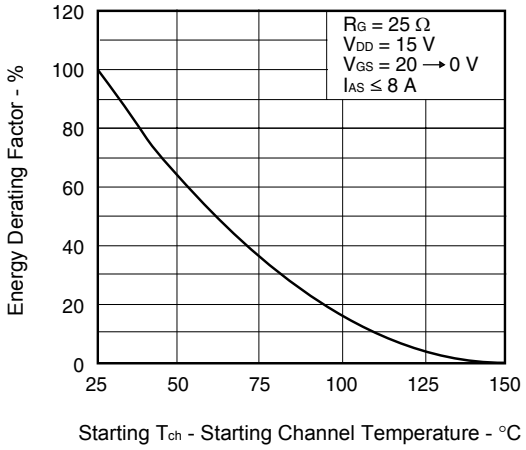
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



SINGLE AVALANCHE CURRENT vs.
INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY
DERATING FACTOR



ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
μPA2755AGR-E1-AT **Note**	Pure Sn (Tin)	Tape 2500 p/reel	Power SOP8 0.08 g TYP.
μPA2755AGR-E2-AT **Note**			

Note Pb-free (This product does not contain Pb in external electrode and other parts.)